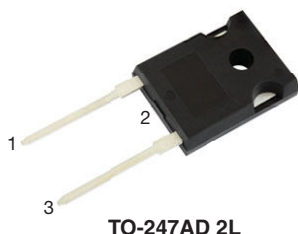
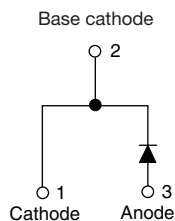


## Ultrafast Soft Recovery Diode, 30 A FRED Pt® Gen 4



TO-247AD 2L



### FEATURES

- Gen 4 FRED Pt® technology
- Low  $I_{RRM}$  and reverse recovery charge
- Very low forward voltage drop
- Polyimide passivated chip for high reliability standard
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRIMARY CHARACTERISTICS

|                       |                    |
|-----------------------|--------------------|
| $I_{F(AV)}$           | 30 A               |
| $V_R$                 | 600 V              |
| $V_F$ at $I_F$        | 1.19 V             |
| $t_{rr}$ typ.         | see Recovery table |
| $T_J$ max.            | 175 °C             |
| Package               | TO-247AD 2L        |
| Circuit configuration | Single             |

### DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

### ABSOLUTE MAXIMUM RATINGS

| PARAMETER                                  | SYMBOL         | TEST CONDITIONS                              | MAX.        | UNITS |
|--|----------------|--|-------------|-------|
| Peak repetitive reverse voltage            | $V_{RRM}$      |  | 600         | V     |
| Average rectified forward current          | $I_{F(AV)}$    | $T_C = 131$ °C                               | 30          | A     |
| Non-repetitive peak surge current          | $I_{FSM}$      | $T_C = 25$ °C, $t_p = 8.3$ ms half sine wave | 240         |       |
| Operating junction and storage temperature | $T_J, T_{Stg}$ |  | -55 to +175 | °C    |

### ELECTRICAL SPECIFICATIONS ( $T_J = 25$ °C unless otherwise specified)

| PARAMETER                           | SYMBOL        | TEST CONDITIONS                   | MIN. | TYP. | MAX. | UNITS   |
|-------------------------------------|---------------|-----------------------------------|------|------|------|---------|
| Breakdown voltage, blocking voltage | $V_{BR}, V_R$ | $I_R = 100$ $\mu$ A               | 600  | -    | -    | V       |
| Forward voltage                     | $V_F$         | $I_F = 30$ A                      | -    | 1.36 | 1.6  |         |
|                                     |               | $I_F = 60$ A                      | -    | 1.6  | -    |         |
|                                     |               | $I_F = 30$ A, $T_J = 125$ °C      | -    | 1.23 | -    |         |
|                                     |               | $I_F = 60$ A, $T_J = 125$ °C      | -    | 1.5  | -    |         |
|                                     |               | $I_F = 30$ A, $T_J = 150$ °C      | -    | 1.19 | 1.35 |         |
|                                     |               | $I_F = 60$ A, $T_J = 150$ °C      | -    | 1.48 | -    |         |
| Reverse leakage current             | $I_R$         | $V_R = V_R$ rated                 | -    | -    | 50   | $\mu$ A |
|                                     |               | $T_J = 125$ °C, $V_R = V_R$ rated | -    | -    | 500  |         |
| Junction capacitance                | $C_T$         | $V_R = 600$ V                     | -    | 18.3 | -    | pF      |

**DYNAMIC RECOVERY CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER               | SYMBOL    | TEST CONDITIONS                     | MIN. | TYP. | MAX. | UNITS |
|-------------------------|-----------|-------------------------------------|------|------|------|-------|
| Reverse recovery time   | $t_{rr}$  | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 65   | -    | ns    |
|                         |           | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 90   | -    |       |
| Peak recovery current   | $I_{RRM}$ | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 18   | -    | A     |
|                         |           | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 32   | -    |       |
| Reverse recovery charge | $Q_{rr}$  | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 850  | -    | nC    |
|                         |           | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 1850 | -    |       |

**THERMAL - MECHANICAL SPECIFICATIONS**

| PARAMETER                               | SYMBOL     | TEST CONDITIONS        | MIN.       | TYP. | MAX.       | UNITS                  |
|---|------------|------------------------|------------|------|------------|------------------------|
| Thermal resistance, junction to case    | $R_{thJC}$ |                        | -          | -    | 0.9        | $^{\circ}\text{C/W}$   |
| Thermal resistance, junction to ambient | $R_{thJA}$ | Typical socket mount   | -          | -    | 40         |                        |
| Thermal resistance, case to heatsink    | $R_{thCS}$ |                        | -          | 0.4  | -          |                        |
| Weight                                  |            |                        | -          | 6.0  | -          | g                      |
|   |            |                        | -          | 0.21 | -          | oz.                    |
| Mounting torque                         |            |                        | 6.0<br>(5) | -    | 12<br>(10) | kgf · cm<br>(lbf · in) |
| Marking device                          |            | Case style TO-247AD 2L | E4PU3006L  |      |            |                        |

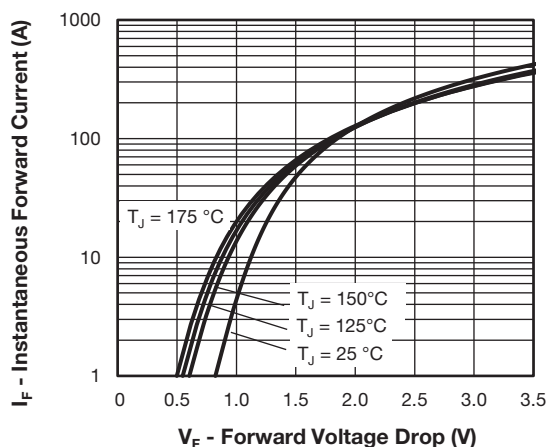


Fig. 1 - Typical Forward Voltage Drop Characteristics

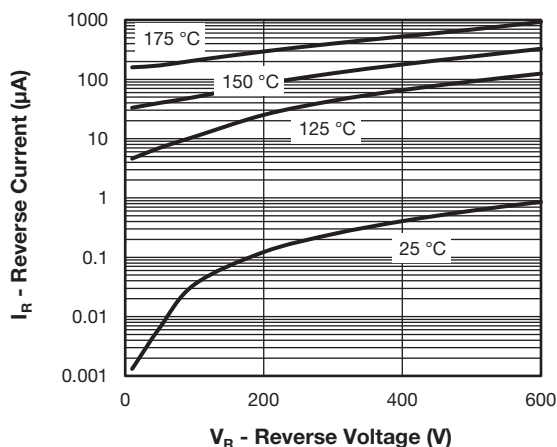


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

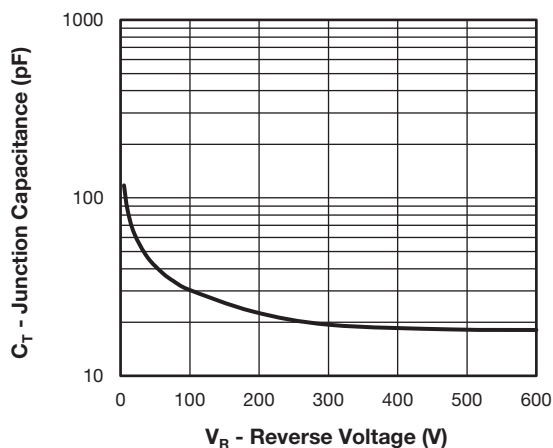


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

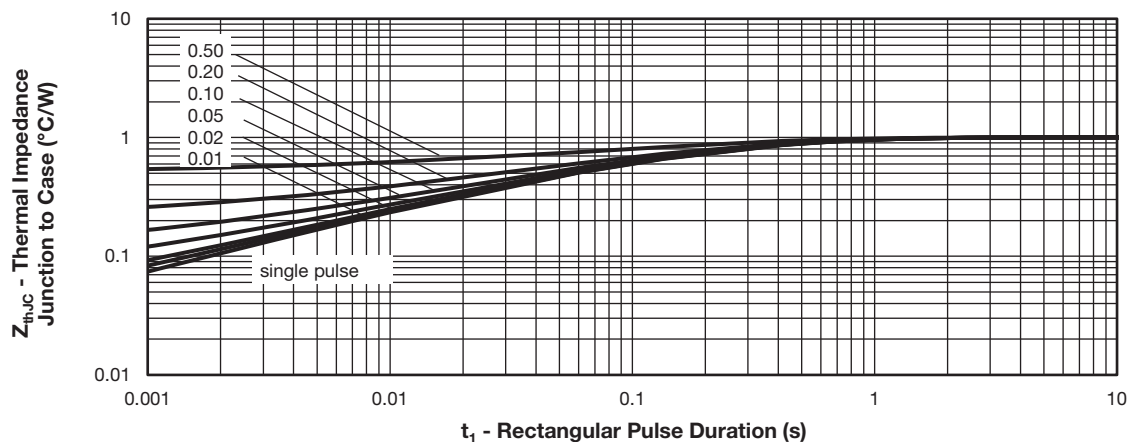
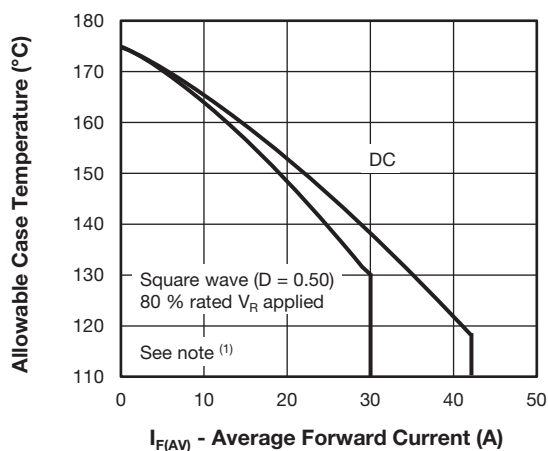

Fig. 4 - Max. Thermal Impedance  $Z_{thJC}$  Characteristics


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

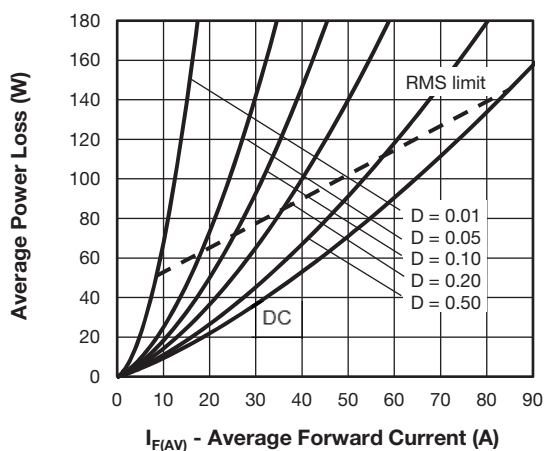
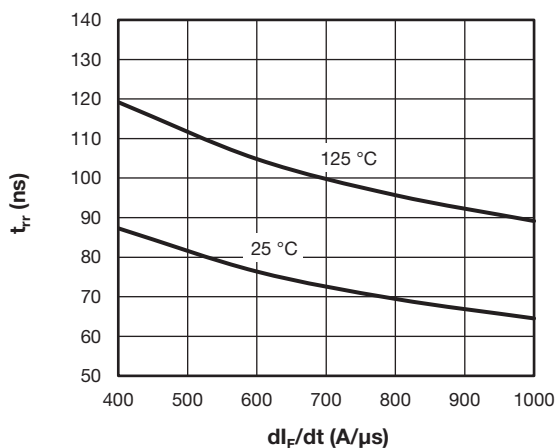
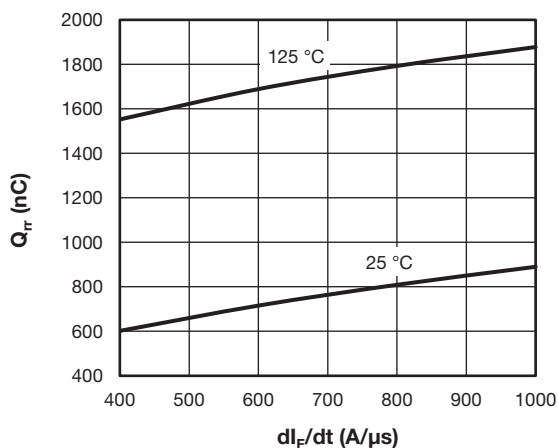
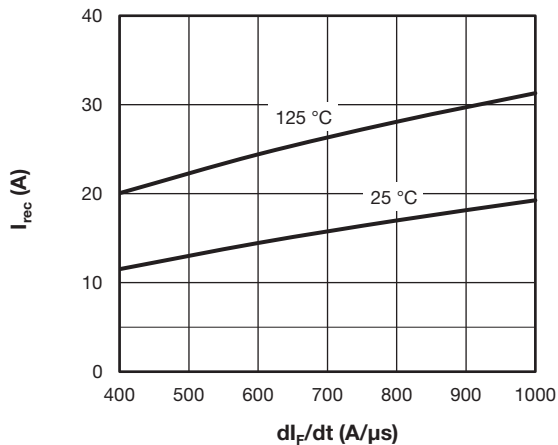


Fig. 6 - Forward Power Loss Characteristics

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see Fig.5)  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_R$  = rated  $V_R$


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$ 

Fig. 9 - Typical Reverse Current vs.  $dI_F/dt$

**ORDERING INFORMATION TABLE**

|             |            |          |  |          |          |           |           |          |            |
|-------------|------------|----------|--|----------|----------|-----------|-----------|----------|------------|
| Device code | <b>VS-</b> | <b>E</b> | <b>4</b>   | <b>P</b> | <b>U</b> | <b>30</b> | <b>06</b> | <b>L</b> | <b>-N3</b> |
|             | 1          | 2        | 3  | 4        | 5        | 6         | 7         | 8        | 9          |
|             | 1          | -        | Vishay Semiconductors product  |          |          |           |           |          |            |
|             | 2          | -        | Circuit configuration:<br>E = single diode   |          |          |           |           |          |            |
|             | 3          | -        | FRED Pt Gen 4  |          |          |           |           |          |            |
|             | 4          | -        | P = TO-247 package   |          |          |           |           |          |            |
|             | 5          | -        | Process type:<br>U = ultrafast recovery  |          |          |           |           |          |            |
|             | 6          | -        | Current rating (30 = 30 A)   |          |          |           |           |          |            |
|             | 7          | -        | Voltage rating (06 = 600 V)  |          |          |           |           |          |            |
|             | 8          | -        | Package: L = long lead   |          |          |           |           |          |            |
|             | 9          | -        | Environmental digit:<br>-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free |          |          |           |           |          |            |

**ORDERING INFORMATION** (Example)

| PREFERRED P/N   | QUANTITY PER TUBE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION   |
|-----------------|-------------------|------------------------|-------------------------|
| VS-E4PU3006L-N3 | 25                | 500                    | Antistatic plastic tube |

**LINKS TO RELATED DOCUMENTS**

|                          |  |
|--------------------------|--|
| Dimensions               | <a href="http://www.vishay.com/doc?95536">www.vishay.com/doc?95536</a> |
| Part marking information | <a href="http://www.vishay.com/doc?95648">www.vishay.com/doc?95648</a> |



### TO-247AD 2L

**DIMENSIONS** in millimeters and inches



| SYMBOL | MILLIMETERS |       | INCHES |       | NOTES |
|--------|-------------|-------|--------|-------|-------|
|        | MIN.        | MAX.  | MIN.   | MAX.  |       |
| A      | 4.65        | 5.31  | 0.183  | 0.209 |       |
| A1     | 2.21        | 2.59  | 0.087  | 0.102 |       |
| A2     | 1.50        | 2.49  | 0.059  | 0.098 |       |
| b      | 0.99        | 1.40  | 0.039  | 0.055 |       |
| b1     | 0.99        | 1.35  | 0.039  | 0.053 |       |
| b2     | 1.65        | 2.39  | 0.065  | 0.094 |       |
| b3     | 1.65        | 2.34  | 0.065  | 0.092 |       |
| c      | 0.38        | 0.89  | 0.015  | 0.035 |       |
| c1     | 0.38        | 0.84  | 0.015  | 0.033 |       |
| D      | 19.71       | 20.70 | 0.776  | 0.815 | 3     |
| D1     | 13.08       | -     | 0.515  | -     | 4     |
| D2     | 0.51        | 1.35  | 0.020  | 0.053 |       |

| SYMBOL | MILLIMETERS |       | INCHES    |       | NOTES |
|--------|-------------|-------|-----------|-------|-------|
|        | MIN.        | MAX.  | MIN.      | MAX.  |       |
| E      | 15.29       | 15.87 | 0.602     | 0.625 | 3     |
| E1     | 13.46       | -     | 0.53      | -     |       |
| e      | 5.46 BSC    |       | 0.215 BSC |       |       |
| Ø K    | 0.254       |       | 0.010     |       |       |
| L      | 19.81       | 20.32 | 0.780     | 0.800 |       |
| L1     | 3.71        | 4.29  | 0.146     | 0.169 |       |
| Ø P    | 3.56        | 3.66  | 0.14      | 0.144 |       |
| Ø P1   | -           | 6.98  | -         | 0.275 |       |
| Q      | 5.31        | 5.69  | 0.209     | 0.224 |       |
| R      | 4.52        | 5.49  | 0.178     | 0.216 |       |
| S      | 5.51 BSC    |       | 0.217 BSC |       |       |

#### Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Contour of slot optional
- Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions D1 and E1
- Lead finish uncontrolled in L1
- Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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